## Twofold enhancement in reliability of organic light emitting diodes with thermally-induced morphological change of organic layer Japan Advanced Institute of Science and Technology (JAIST) °(D2) Duy Cong Le, (M2) Li Yining, Heisuke Sakai, Hideyuki Murata. E-mail: murata-h@jaist.ac.jp

The reliability enhancement because of annealing of organic light emitting diodes (OLEDs) fabricated under high vacuum condition  $(10^{-6} \sim 10^{-7} \text{ Torr})$  can be as a result of the morphological change of organic layers and/or the removal of residual water from the deposited material after annealing.<sup>1-2)</sup> Recently, we achieved the lower region of ultra-high vacuum (UHV) condition  $(10^{-10} \sim 10^{-11} \text{ Torr})$  with extremely low concentration of residual water by utilizing non-evaporable getter pumps (NEGPs) and regular turbo molecular pumps (TMPs) in OLED deposition chamber.<sup>3)</sup> In this report, we demonstrate twofold enhancement in reliability of OLED can be achieved by the thermally-induced morphological change of organic layers.

OLEDs with a structure of ITO/MoO<sub>3</sub>(0.75nm)/ $\alpha$ -NPD(90nm)/Alq<sub>3</sub>(70nm)/LiF(1nm)/Al(100nm) were fabricated in UHV chamber pumped with TMPs and NEGPs. After fabrication, OLEDs were thermally annealed in air at 50 °C and 75 °C for 3 h, then decreased to 25 °C and left for 30 min before characterization. The reliability of OLED was measured at

a constant current density of 50 mA/cm<sup>2</sup>.

The operation time to reach to 90% of initial luminance  $(LT_{90})$  of the OLED after annealing at 75 °C is 236 h, which is about two times compared to that  $(LT_{90}=136 \text{ h})$  of the as-deposited OLED (Fig. 1). The decrease in thickness of film ( $\alpha$ -NPD/Alq<sub>3</sub>) suggests that thermal annealing may increase the density of organic layers.

The p-polarized multiple-angle incidence resolution spectrometry (pMAIRS) reveal that the orientation angle ( $\phi$ ) with respect to surface normal is about 61 degree and slightly increase after annealing. This result suggests that  $\alpha$ -NPD molecules horizontally oriented after deposition and slightly more lie down after annealing (Fig. 2). Such molecular change is evident with the increase of density resulting from the more packed  $\alpha$ -NPD molecules (Fig. 3). As shown in Fig. 2, the increase in photoluminescence intensity from  $\alpha$ -NPD molecules after annealing indicates the decrease of nonradiative deactivation centers followed by photochemical reactions of excited states in highly packed  $\alpha$ -NPD.<sup>4</sup> This could be the reason for the enhancement in short-term reliability of OLEDs.

## References

[1] G. T. Chen, et al., J. Electrochem. Soc., 154, J159 (2007).

- [2] A. B. Djurišić, et al., Appl. Phys. A, 78, 375 (2004).
- [3] D. C. Le et al., Appl. Phys. Express., 10, 071601 (2017).
- [4] K. A. Osipov, et al., Thin Solid Films, 515, 4834 (2007).

Key words: reliability, annealing, molecular orientation.

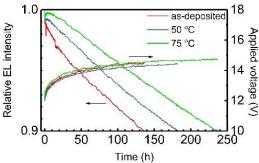


Fig. 1. Luminance/initial luminance-time characteristics of OLEDs.

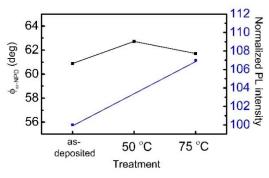


Fig. 2. Orientation angle of  $\alpha$ -NPD,  $\phi_{\alpha$ -NPD, and normalized PL intensity.

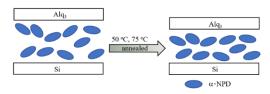


Fig. 3. Morphological change of  $\alpha$ -NPD film.